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Form PTO-1595

02-28-2007

Attorney Docket No.: SUZU1510

SHEET

To the Honorable Commissioner for F  
thereof.

103376259

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1. Name of Conveying party(ies):

Toshiba America Electronic  
Components, Inc.

Additional name(s) of conveying party(ies)

Attached? ☐ Yes ☒ No

2. Name and address of receiving Party(ies):

Kabushiki Kaisha Toshiba  
1-1 Shibaura 1-chome  
Minato-ku, Tokyo  
Japan

Additional name(s) &amp; address(es) attached?

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ : Merger☐ Security Agreement☐ : Change of name☐ Other:

Execution Date: 02/14/2007

Application number(s) or patent number(s): 11/137,296

If this document is being filed together with a new application, the execution date of the application is: na

A. Patent Application No.(s)

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PATENT

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**A S S I G N M E N T**

We, Toshiba America Electronic Components, Inc., a corporation organized under the laws of California, located at 19900 MacArthur Blvd., Suite 400, Irvine, California 92612, U.S.A., the assignee of the following U.S. Patent Application:

<u>SERIAL NO.</u>	<u>DATE FILED</u>	<u>INVENTOR</u>	<u>TITLE OF INVENTION</u>
11/137,296	05/25/2005	Satoru Takase	System and Method for Configuring Conductors within an Integrated Circuit to Reduce Impedance Variation Caused by Connection Bumps

hereby assign the entirety of our right, title and interest in said U.S. Patent Application, including all divisions, reissues, continuations, substitutions and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property, including rights of priority, resulting from the filing of any said application to KABUSHIKI KAISHA TOSHIBA, a Japanese corporation, located at 1-1 Shibaura 1-chome, Minato-ku, Tokyo, Japan, their successors, assigns, or other legal representatives.

The undersigned is authorized to sign this document on behalf of the corporation.

TOSHIBA AMERICA ELECTRONIC  
COMPONENTS, INC.

By:   
Name: Hideya Sakaida  
Title: President

Date: 2/14/2007

